

PCN-243589

Product Change Notice

Issue Date: 15-Feb-2022 Updated: 24-Jun-2022 Updated: 14-Sep-2022 Updated: 18-Jan-2023

Change Description:

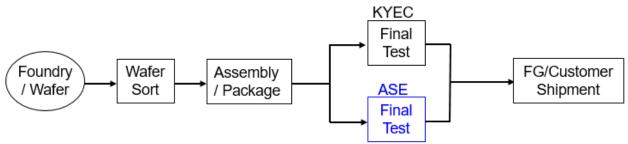
Add ASE-M as a 2nd source Final Test site

Parts Affected:

BCM89830A0BWMLGT BCM89830A0BWMLG BCM89832A0BWMLGT BCM89832A0BWMLG

Description and Extent of Change:

Electrical Final Testing (FT) is currently performed on this product at KYEC (Chu-Nan, Taiwan R.O.C.). Broadcom will add ASE (Malaysia) as a 2nd source for FT. There is no change to the Foundry, Wafer Sort, or Assembly locations or processes – see updated flow below.



Note that ASE-M is a Broadcom qualified automotive supplier.

Reasons for Change:

Increase final test capacity and flexibility

Effect of Change on Fit, Form, Function, Quality, or Reliability:

The device specification, test limits, SYA/SBL limits, and S-PAT will remain the same, which will ensure product electrical performance remains the same. Appropriate correlation was performed to ensure <u>no impact</u> on Fit, Form, Function, Quality, or Reliability.

Effective Date of Change:

Product shipments using this change will begin after the dates shown in the table below. Timing of shipment of parts tested at ASE-KH will vary by part number depending on customer demand and inventory levels.

Part Number	Earliest Ship Date
BCM89832	31-Oct-2022
BCM89830	31-Jan-2023



Correlation Information:

The KYEC-to-ASE correlation has been completed.

Part Number	Correlation Date
BCM89832	Complete
BCM89830	Complete

See the table below for correlation details. These devices use the same silicon die and package type (WQFN).

	ASE Final Test				
Correlation Item	BCM89832		BCM89830		
Tester	Same as at KYEC		Same as at KYEC		
Test DIB	Same as at KYEC		Same as at KYEC		
Test Program	Same as at KYEC		Same as at KYEC		
Test time / # of tests	Same as at KYEC		Same as at KYEC		
SYL/SBL limits	Same as at KYEC		Same as at KYEC		
S-PAT limits	Same as at KYEC		Same as at KYEC		
	Result	OK/NOK	Result	OK/NOK	
Tester MSA	Pass	OK	Pass	OK	
Reproducibility:	Hot Temp:	OK	Hot Temp:	OK	
 Loop 20x; 4 units/site (4 sites) @ Hot Temp 	320/320 Pass		320/320 Pass		
 Loop 20x; 4 units/site (4 sites) @ Cold Temp 	Cold Temp:		Cold Temp:		
	320/320 Pass		320/320 Pass		
Repeatability:	Hot Temp:	OK	Hot Temp:	OK	
 Loop 50x; 1 unit @ Hot Temp 	50/50 Pass		50/50 Pass		
 Loop 50x; 1 unit @ Cold Temp 	Cold Temp:		Cold Temp:		
	50/50 Pass		50/50 Pass		
Yield/reject correlation/comparison	Hot Temp:	OK	Hot Temp:	OK	
(≥25 KGU & ≥25 KBU)*	KGU 25/25 Pass;		KGU 25/25 Pass;		
	KBU 0/25 Pass		KBU 0/25 Pass		
	Cold Temp:		Cold Temp:		
	KGU 25/25 Pass;		KGU 25/25 Pass;		
	KBU 0/25 Pass		KBU 0/25 Pass		
Analog test parameter correlation (500u/lot)	3 lots	OK	3 lots	OK	

^{*}Note: KGU = Known Good Units; KBU = Known Bad Units

Please contact your Broadcom field sales engineer or Contact Center for any questions or support requirements. Please return any response as soon as possible, but **not to exceed 30 days**.